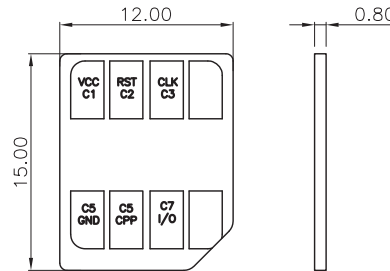
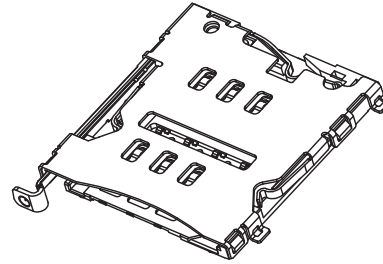
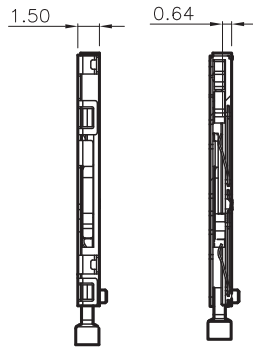
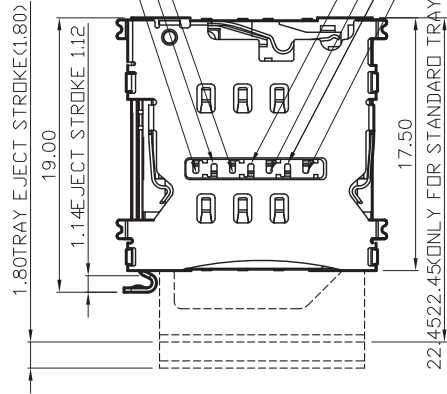


| REV. | DESCRIPTION | DATE |
|------|-------------|--------------|
| A | RELEASE | Mar 20, 2013 |

C2:Reset(RST)
C5:Ground
C1:Supply Voltage Vcc
C6:Programming Voltage Vpp
C3:Clock(CLK)
C7:I/O
SW



MATERIALS

1. HOUSING : THERMOPLASTIC (UL 94V-0) .
2. TERMINAL : COPPER ALLOY, PLATING SEE TABLE
3. SHELL : STAINLESS STEEL,NICKEL PLATED OVERALL.

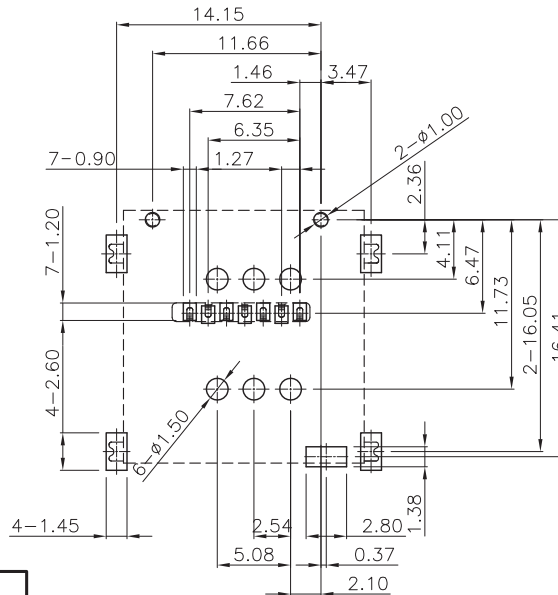
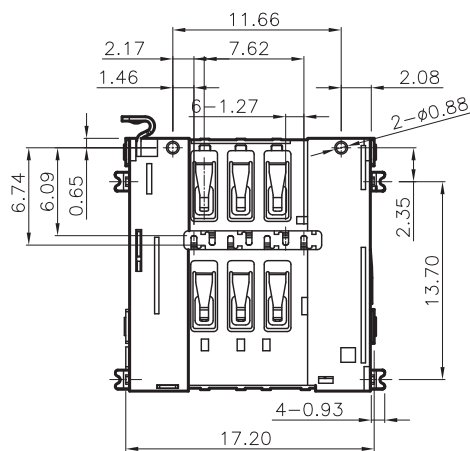
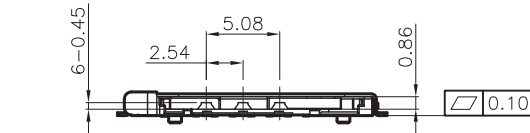
SPECIFICATION

1. CURRENT RATING : 0.5 AMP
2. DIELECTRIC WITHSTANDING VOLTAGE : 500V AC MIN.FOR 1 MINUTE
3. INSULATION RESISTANCE : 100MΩ MIN.
4. CONTACT RESISTANCE : 30mΩ MAX.
5. OPERATING TEMPERATURE : -40°C TO +85°C.

PART NUMBER INFORMATION :

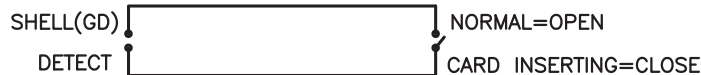
5100106-X1110S-X

SERIES CODE | SMT 90° | SIM CARD | SINGLE TYPE | NUMBER OF POSITIONS | R:RoHS | H:HALOGEN FREE | FOLLOW NUMBER | WITH PUSH | INSERT TYPE | PLATING SEE TABLE



RECOMMEND PCB LAYOUT
TOLERANCE: ±0.05
TOP VIEW

CIRCUIT DIAGRAM



| DESCRIPTION OF PLATING ON TERMINALS | | | |
|-------------------------------------|------------|-----|------------|
| NO. | EXPLAIN | NO. | EXPLAIN |
| 0 | GOLD FLASH | 3 | GOLD 15u" |
| 1 | GOLD 5u" | T | TIN PLATED |
| 2 | GOLD 10u" | H | G/F + TIN |

| | | |
|--|---|---|
| TOLERANCE .0=±0.25 .00=±0.15 .000=±0.05 ANG.=±3° | DRAWER CHECK APP'D PRODUCT SPEC. | 汉硕电子科技有限公司 NAME MICRO SIM CARD PUSH PUSH 1.5H |
| UNITS : mm | SCALE NONE | DRAW NO. |
| SIZE A6 | SHEET 1 OF 1 | REV. A |
| R5100106-X1110S-X | | |